



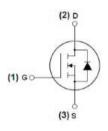
MJ N-Channel Enhancement Mode Power MOSFET

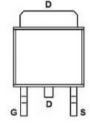
Description

The MJ1520K uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ◆ V_{DS} =150V,I_D =20A R_{DS(ON)} <80mΩ @ V_{GS}=10V (Typ:65mΩ) R_{DS(ON)} <90mΩ @ V_{GS}=7V (Typ:70mΩ)
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation





Application

Boost converters

◆ LED backlighting

Uninterruptible power supply



Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ1520K	MJ1520K	TO-252-2L	ii ii	-	9

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	150	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lD	20	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	14	А
Pulsed Drain Current	Ідм	40	А
Maximum Power Dissipation	PD	90	W
Derating factor		0.6	W/°C
Single pulse avalanche energy (Note 5)	Eas	80	mJ
Operating Junction and Storage Temperature Range	TJ,TsTG	-55 To 175	℃

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.7	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	150	165	-	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =150V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	2	3.4	4	V
Decision Courses Co. Challe Bestiates		V _{GS} =10V, I _D =10A	-	65	80	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =7V, I _D =10A	-	70	90	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =10A	-	20	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	Clss		-	1810	-	PF
Output Capacitance	Coss	V _{DS} =75V,V _{GS} =0V F=1.0MHz	-	61	_	PF
Reverse Transfer Capacitance	Crss		-	45	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}		-	15.5	_	nS
Turn-on Rise Time	tr	VDD=75V,RL=5Ω	-	8.5	-	nS
Turn-Off Delay Time	t _{d(off)}	Vgs=10V,Rgen=3Ω	-	19.5	-	nS
Turn-Off Fall Time	tf	-	-	7	-	nS
Total Gate Charge	Qg		_	45	-	nC
Gate-Source Charge	Qgs	V _{DS} =75V,I _D =10A V _{GS} =10V	-	9	-	nC
Gate-Drain Charge	Qgd	-	-	12	-	nC
Drain-Source Diode Characteristics	I					<u>I</u>
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	-	_	1.2	V
Diode Forward Current (Note 2)	Is		_	_	20	А
Reverse Recovery Time	trr	TJ=25°C, IF=10A	-	32	_	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	_	53	_	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is no	ealiaible(tı	ırn-on is d	ominated h	V I S+I D

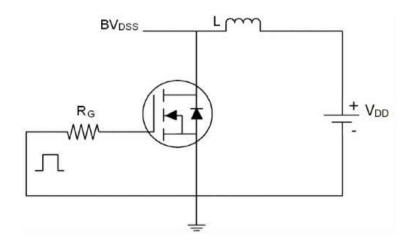
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- 5 EAS condition: Tj=25°C, VDD=50V, Vg=10V, L=0.5mH, Rg=25 Ω

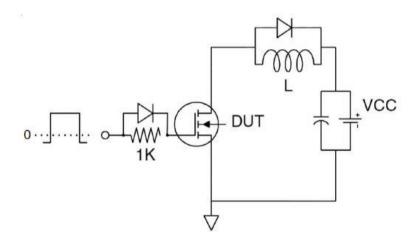




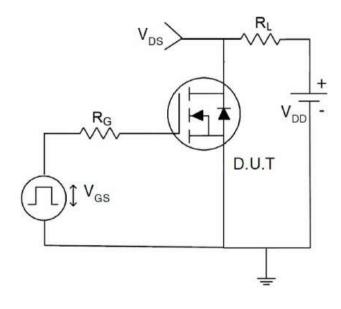
Test circuit



Eas test Circuit



Gate charge test Circuit



Switch Time Test Circuit



20

15

10

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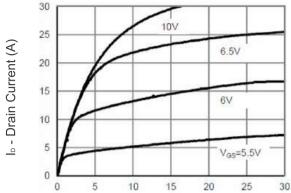
0 2

lo - Drain Current (A)

V_{ps}=5V

3

Typical Electrical and Thermal Characteristics (Curves)



2.8 Normalized On-Resistance V_{as}=10V 2.4 ID=10A 2 1.6 1.2 0.8 0 25 75 100 125 150 175 200

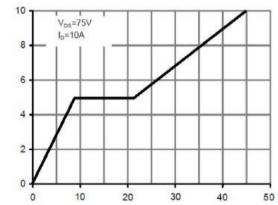
Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

Vgs Gate-Source Voltage (V)

T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature





Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

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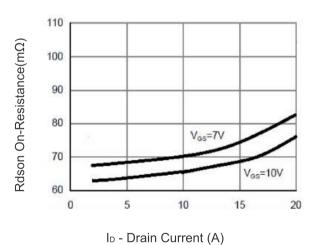
25℃

6

125℃

Qg Gate Charge (nC)

Figure 5 Gate Charge



Is - Reverse Drain Current (A)

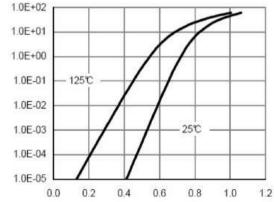
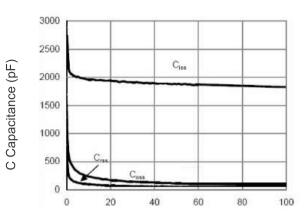


Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



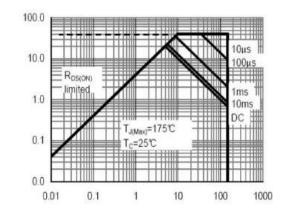
lo - Drain Current (A)

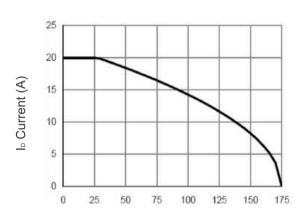


120 100 Power Dissipation (W) 80 60 40 20 0 0 25 50 75 100 125 150

Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds

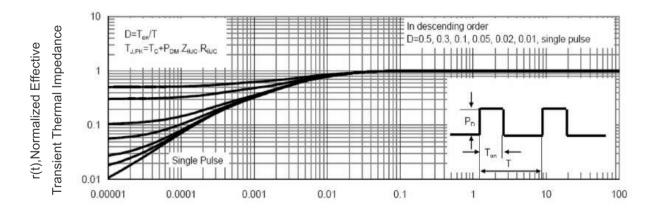
T_J -Junction Temperature(°C) Figure 9 Power De-rating





Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

T_J -Junction Temperature(°C) Figure 10 In Current- Junction Temperature



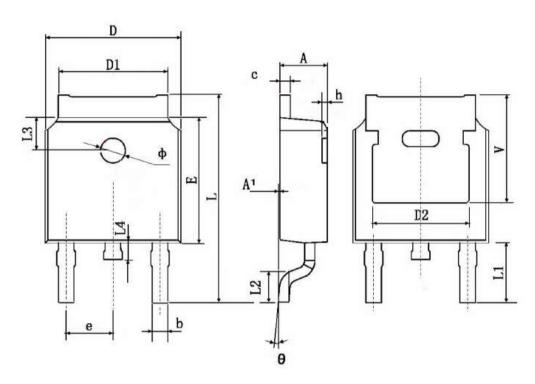
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350	5.350 TYP.		TYP.



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